

									1
				Base	Finish	Mask			
Layer	Stack up	Description	Impedance ID			Thickness	Туре	εr	Notes-1
	·	•							
		Soldermask				0.020	SolderMask	4.100	10
1 7		Foil	1, 2, 3	0.012	0.035		Foil		0
		VT47-1080			0.075		PREPREG		
2		Foil			0.032		Foil	4.000	0
2									U
		VT47-106			0.053		PREPREG	4.000	
	L 3	VT47-106			0.053		PREPREG	4.000	
3			4, 5, 6		0.035			4.000	
1	1 1 2 2	VT-47			0.203 0.018		Core	4.600	
7	3	VT47-2113			0.016		PREPREG	4 000	
_	8	V147-2113					PREPREG	4.000	
5	H 2	VT-47			0.018 0.102		Core	4 120	
6 9:					0.018		00.0	20	
9 /		VT47-106		0.053	0.053		PREPREG	4.000	
0.0		VT47-106		0.053	0.053		PREPREG		
7 ⁺ 9.	8	1 11111100			0.018				
, –	3	VT-47			0.102		Core	4.120	
8				0.018	0.018				
	8	VT47-2113		0.096	0.096		PREPREG	4.000	
9					0.018				
		VT-47		0.203	0.203		Core	4.600	
10		<u> </u>			0.035				
		VT47-106		0.053	0.053		PREPREG	4.000	
		VT47-106		0.053	0.053		PREPREG	4.000	
11		Foil		0.009	0.032		Foil		0
		VT47-1080		0.075	0.075		PREPREG	4.000	
12		Foil			0.035				0
1		Soldermask	, ,		2.300	0.020	SolderMask		
		Soluermask				0.020	SoluerMask	4.100	10

Impedance ID	Structure Name	Structure Image	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Trace	Ground Strip Separation (D1)	Target Impedance	Calculated Impedance	
1	Coated Microstrip 1B		1	2	0	0.093	0.000	0.000	55.000	55.060	10.000
2	Edge Coupled Coated Microstrip 1B		1	2	0	0.101	0.114	0.000	90.000	90.060	10.000
3	Edge Coupled Coated Microstrip 1B		1	2	0	0.090	0.160	0.000	100.000	100.300	10.000
4	Offset Stripline 1B1A	_	3	2	4	0.080	0.000	0.000	55.000	53.620	10.000

StackName: iMX6_Rex_V1I1_PCB_12L_VT47_mv	Version: 1	Revision:	Modification:	Date of Revision:	Editor	
Date: 31/10/2013	Associated Documents:					
Author: DM						Page 1/3
Department: IDS]
Site: Tewkesbury						





Impedance ID	Structure Name	Structure Image	Impedance Signal Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width (W1)	Trace Separation (S1)	Ground Strip Separation (D1)	Target Impedance	Calculated Impedance	Tol (+/- %)	
5	Edge Coupled Offset Stripline 1B1A		3	2	4	0.085	0.115	0.000	90.000	88.390	10.000	
5	Edge Coupled Offset Stripline 1B1A		3	2	4	0.085	0.195	0.000	100.000	98.390	10.000	
	Offset Stripline 1B1A		10	9	11	0.080	0.000	0.000	55.000	53.620	10.000	
	Edge Coupled Offset Stripline 1B1A		10	9	11	0.085	0.115	0.000	90.000	88.390	10.000	
	Edge Coupled Offset Stripline 1B1A	- V.V	10	9	11	0.085	0.195	0.000	100.000	98.390	10.000	
0	Coated Microstrip 1B		12	11	0	0.093	0.000	0.000	55.000	55.060	10.000	
1	Edge Coupled Coated Microstrip 1B		12	11	0	0.101	0.114	0.000	90.000	90.060	10.000	
2	Edge Coupled Coated Microstrip 1B		12	11	0	0.090	0.160	0.000	100.000	100.300	10.000	

Drill Image	1st Layer	2nd Layer	Drill Type	Minimum Size	Fill Type	Data Filenames
	1	12	Mechanical PTH	0.000	None	
7	1	2	Laser PTH	0.100	None	
1	2	3	Laser PTH	0.100	None	
元	12	11	Laser PTH	0.100	None	
人	11	10	Laser PTH	0.100	None	

StackName: iMX6_Rex_V1I1_PCB_12L_VT47_mv	Version: 1	Revision:	Modification:	Date of Revision:	Editor	
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Department: IDS						
Site: Tewkesbury						



Unit: Millimetres



Drill Image	1st Layer	2nd Layer	Drill Type	Minimum Size	Fill Type	Data Filenames	
4 /P	3	10	Mechanical PTH	0.200	None		

<u>Notes</u>

StackName: iMX6_Rex_V1I1_PCB_12L_VT47_mv	Version: 1	Revision:	Modification:	Date of Revision:	Editor	
Date: 31/10/2013	Associated Documents:					Ι.
Author: DM						
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